

### **Amendments to the Specification:**

Please replace the paragraph beginning on page 3, line 16, with the following amended paragraph:

The layer thickness of the dielectric layer  $d_{\text{medium}}$  having the dielectric constant  $\epsilon_{\text{medium}}$  should preferably be selected such that

$$\frac{\epsilon_{\text{medium}} \cdot d_{\epsilon}}{\epsilon \cdot d_{\text{medium}}} > 5$$

so that the metallization structure that is next in the vertical direction is well decoupled. In respect of the decoupling in the horizontal direction, the following should apply

$$\frac{\epsilon_{\text{medium}} \cdot d_{\text{min}}}{d_{\text{medium}} \cdot \epsilon} > 7$$

where  $d_{\text{min}}$  is the minimum distance to the next metallization structure in the plane.